

November 2013

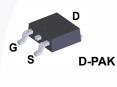
FQD10N20C / FQU10N20C N-Channel QFET[®] MOSFET 200 V, 7.8 A, 360 mΩ

Features

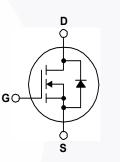
- + 7.8 A, 200 V, $R_{DS(on)}$ = 360 m Ω (Max.) @ V_{GS} = 10 V, I_{D} = 3.9 A
- Low Gate Charge (Typ. 20 nC)
- Low Crss (Typ. 40.5 pF)
- 100% Avalanche Tested

Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.







Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter		FQD10N20CTM / FQU10N20CTU	Unit
V _{DSS}	Drain-Source Voltage		200	V
	Drain Current - Continuous ($T_C = 25^{\circ}C$)		7.8	А
D	- Continuous (T _C = 100°C)		5.0	А
I _{DM}	Drain Current - Pulsed	(Note 1)	31.2	А
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	210	mJ
I _{AR}	Avalanche Current	(Note 1)	7.8	А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	5.0	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		5.5	V/ns
D_	Power Dissipation (T _C = 25°C)		50	W
P _D	- Derate above 25°C		0.4	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
Τ _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C
			500	

Thermal Characteristics

Symbol	Parameter	FQD10N20CTM / FQU10N20CTU	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	2.5	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient, Max.	110	0/10

|--|

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FQD10N20C	FQD10N20CTM	D-PAK	330 mm	16 mm	2500 units
FQU10N20C	FQU10N20CTU	I-PAK	Tube	N/A	70 units

Electrical Characteristics T_C = 25°C unless otherwise noted.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Uni
Off Cha	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	200			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		0.28		V/°(
		V _{DS} = 200 V, V _{GS} = 0 V			10	μA
IDSS	Zero Gate Voltage Drain Current	V _{DS} = 160 V, T _C = 125°C			100	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V_{GS} = -30 V, V_{DS} = 0 V			-100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA	2.0		4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 3.9 A	-	0.29	0.36	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 40 V, I _D = 3.9 A		5.6		S
Dynamic Characteristics C _{iss} Input Capacitance V _{DS} = 25 V, V _{GS} = 0 V,			395	510	pF	
C _{oss}	Output Capacitance	f = 1.0 MHz		97	125	pF
C _{rss}	Reverse Transfer Capacitance			40.5	53	pF
Switchi	ing Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 100 V, I _D = 9.5 A,		11	30	ns
t _r	Turn-On Rise Time	$R_{G} = 25 \Omega$		92	190	ns
t _{d(off)}	Turn-Off Delay Time	5	/	70	150	ns
t _f	Turn-Off Fall Time	(Note 4)	-	72	160	ns
Qg	Total Gate Charge	V _{DS} = 160 V, I _D = 9.5 A,	-	20	26	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V		3.1		nC
Q _{gd}	Gate-Drain Charge	(Note 4)	-	10.5		nC
Drain-S	Source Diode Characteristics ar	nd Maximum Ratings				
I _S	Maximum Continuous Drain-Source Dic			/	7.8	A
I _{SM}	Maximum Pulsed Drain-Source Diode F	Forward Current			31.2	A

IS	Maximum Continuous Drain-Source Diode Forward Current		 	7.8	A
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		 1	31.2	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 7.8 A	 	1.5	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 9.5 A,	 158	1	ns
Q _{rr}	Reverse Recovery Charge	dI _F / dt = 100 A/µs	 0.97	1	μC

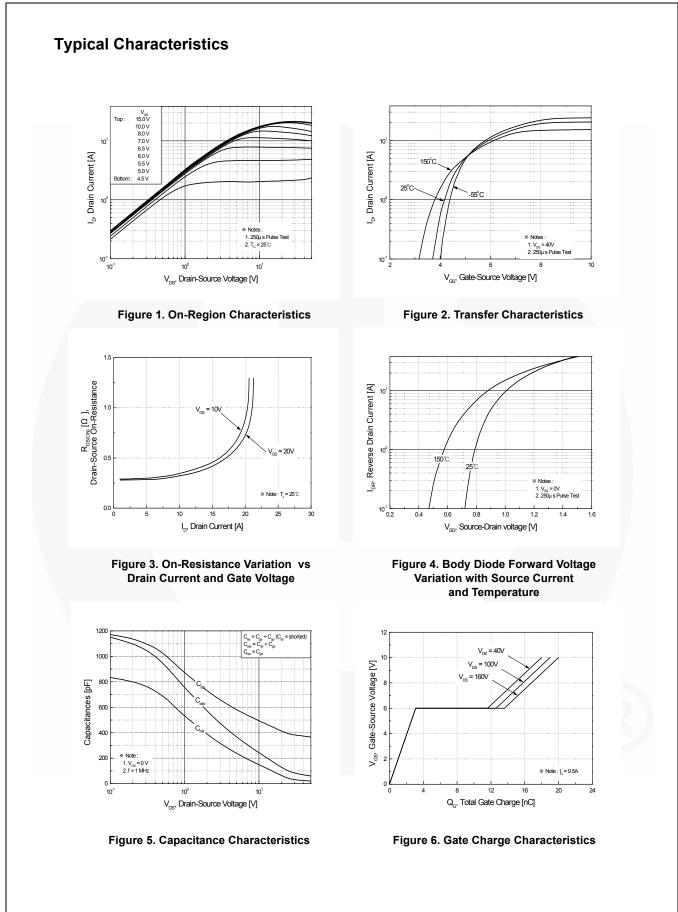
NOTES:

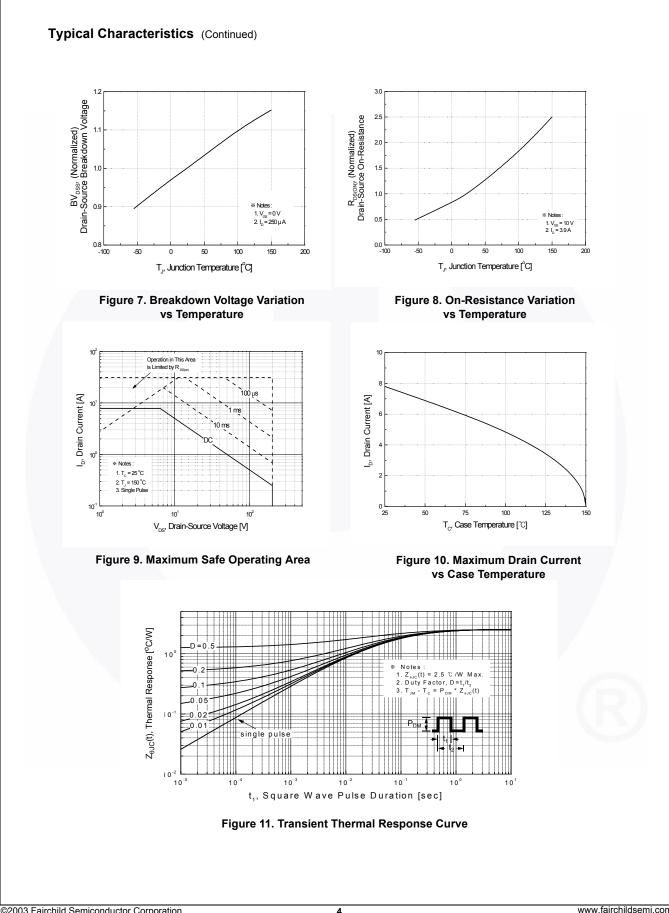
1. Repetitive Rating : Pulse width limited by maximum junction temperature.

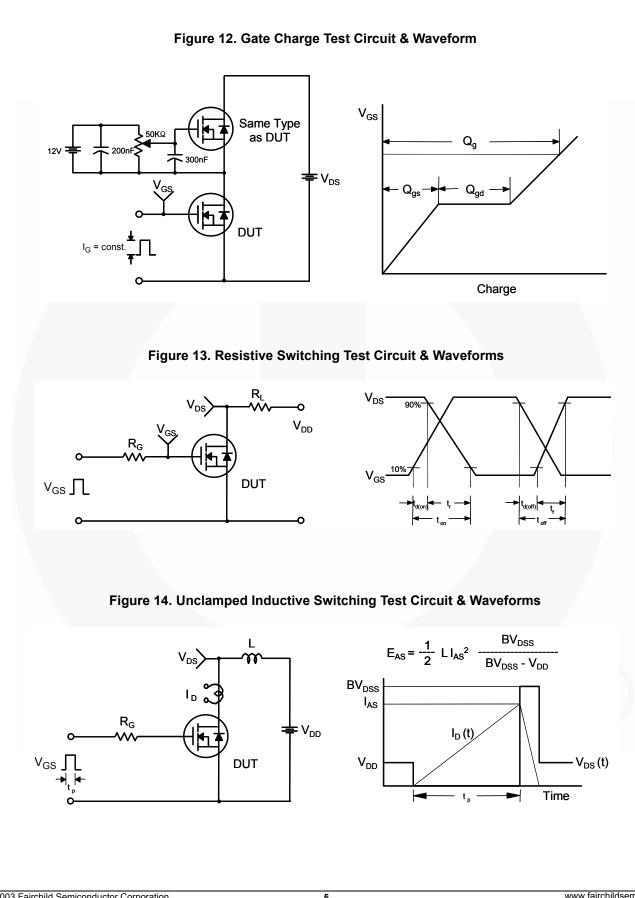
2. L = 5.2 mH, I_{AS} = 7.8 A, V_{DD} = 50 V, R_G = 25 $\Omega,$ starting $\mbox{ T}_{J}$ = 25°C.

3. I_{SD} \leq 9.5 A, di/dt \leq 300 A/µs, V_{DD} \leq BV_{DSS,} starting ~T_J = 25°C.

4. Essentially independent of operating temperature.

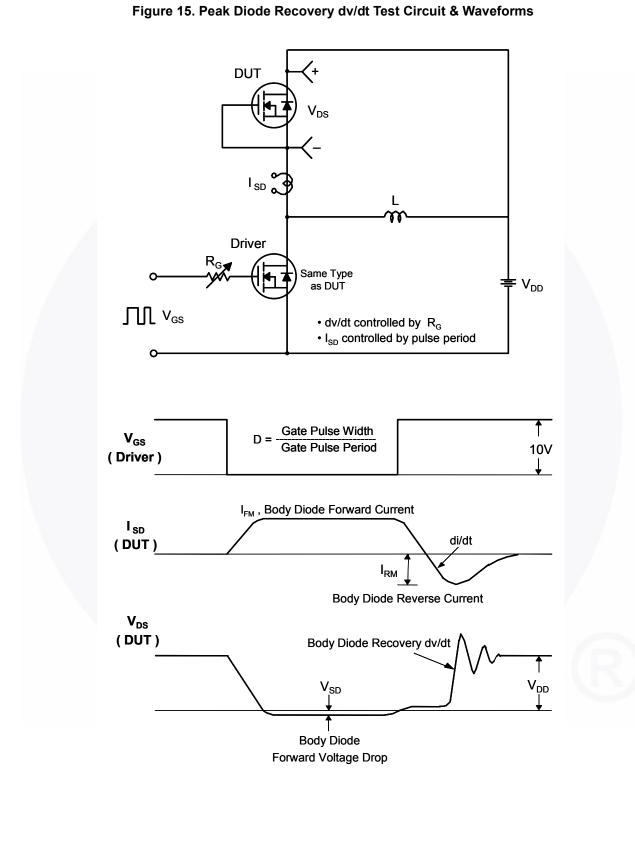


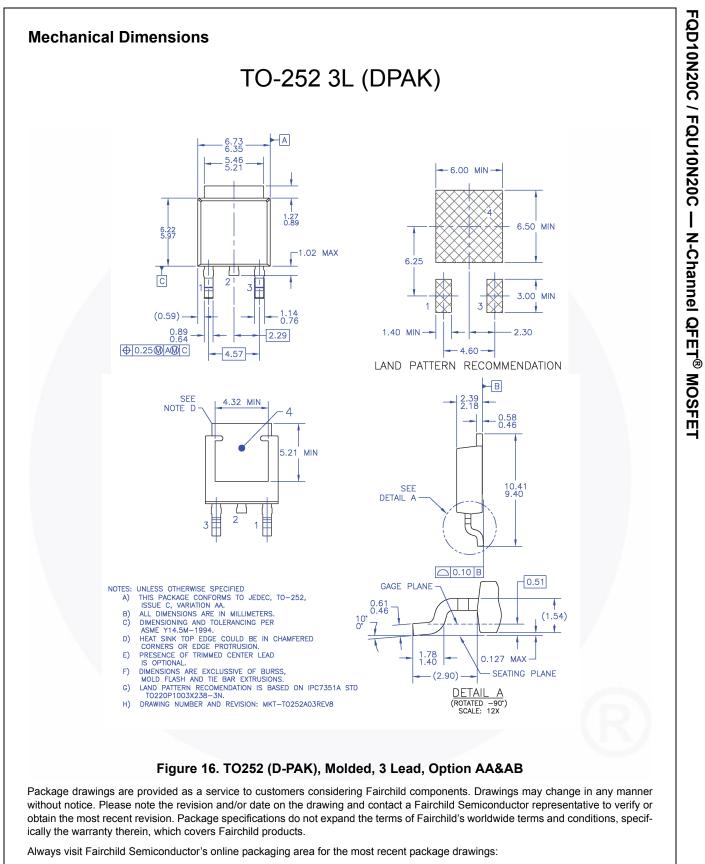




©2003 Fairchild Semiconductor Corporation FQD10N20C / FQU10N20C Rev. C2

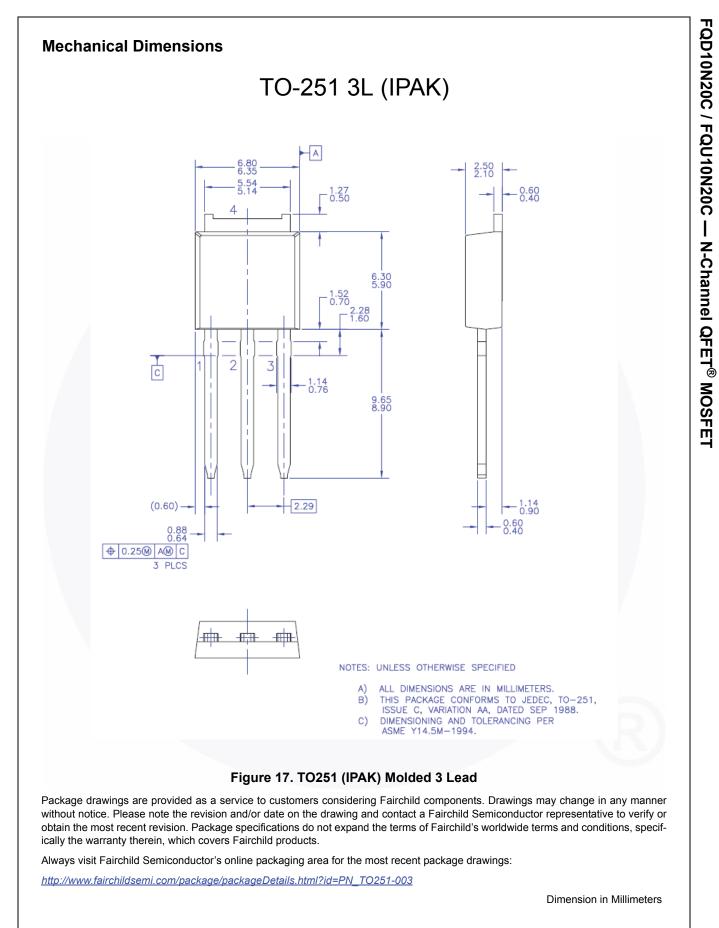
www.fairchildsemi.com





http://www.fairchildsemi.com/package/packageDetails.html?id=PN_TT252-003

Dimension in Millimeters





SEMICONDUCTOR

TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

AccuPower™	F-PFS™	C) _®	Sync-Lock™
AX-CAP [®] *	FRFET®		SYSTEM ®*
BitSiC™	Global Power Resource SM	PowerTrench®	GENERAL
Build it Now™	GreenBridge™	PowerXS™	
CorePLUS™	Green FPS™	Programmable Active Droop [™]	TinyBoost [®] TinyBuck [®]
CorePOWER™	Green FPS™ e-Series™	QFET®	
CROSSVOLT™	Gmax™	QS™	TinyCalc™
CTL™	GTO™	Quiet Series™	TinyLogic®
Current Transfer Logic™	IntelliMAX™	RapidConfigure [™]	TINYOPTO™
DEUXPEED®	ISOPLANAR™	TM U	TinyPower™
Dual Cool™	Marking Small Speakers Sound Loude	r 🔿	TinyPWM™
EcoSPARK [®]	and Better™	Saving our world, 1mW/W/kW at a time™	TinyWire™
EfficentMax™	MegaBuck™	SignalWise™	TranSiC™
ESBC™	MICROCOUPLER™	SmartMax™	TriFault Detect™
	MicroFET™	SMART START™	TRUECURRENT®*
	MicroPak™	Solutions for Your Success™	µSerDes™
Fairchild [®]	MicroPak2™	SPM®	\mathcal{N}
Fairchild Semiconductor [®]	MillerDrive™	STEALTH™	/ Ser <mark>Des</mark> ™
FACT Quiet Series™	MotionMax™	SuperFET®	UHC [®]
FACT Quiet Series ····· FACT [®]	mWSaver®	SuperSOT™-3	Ultra FRFET™
FAST®	OptoHiT™	SuperSOT™-6	UniFET™
	OPTOLOGIC®	SuperSOT™-8	VCX™
FastvCore™	OPTOPLANAR [®]	SupreMOS [®]	VisualMax™
FETBench™		SyncFET™	VoltagePlus™
FPS™		Oynor ET	XS™

*Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used here in:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

FQD10N20C / FQU10N20C — N-Channel QFET[®] MOSFET

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Fairchild Semiconductor: FQD10N20CTM